

Title: METHOD FOR MANUFACTURING A RECLAIMABLE TEST PATTERN WAFER FOR CMP APPLICATIONS

Application No.: 09/752,610 Doc

Docket No.:LAM2P221

Inventor: LACY

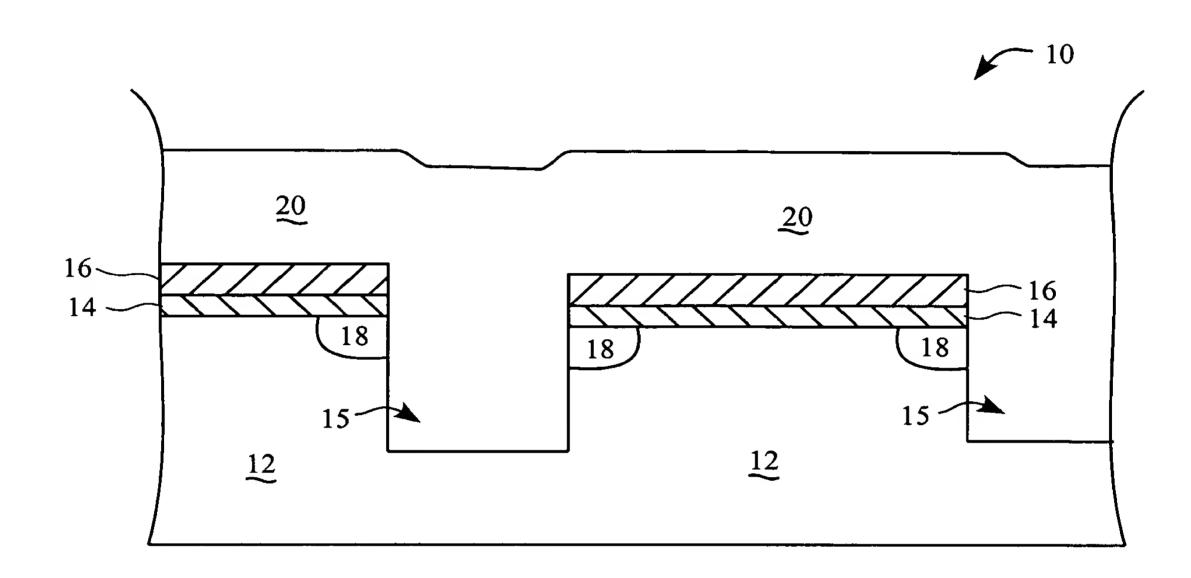


FIG. 1 (Prior Art)

WAFER FOR CMP APPLICATIONS

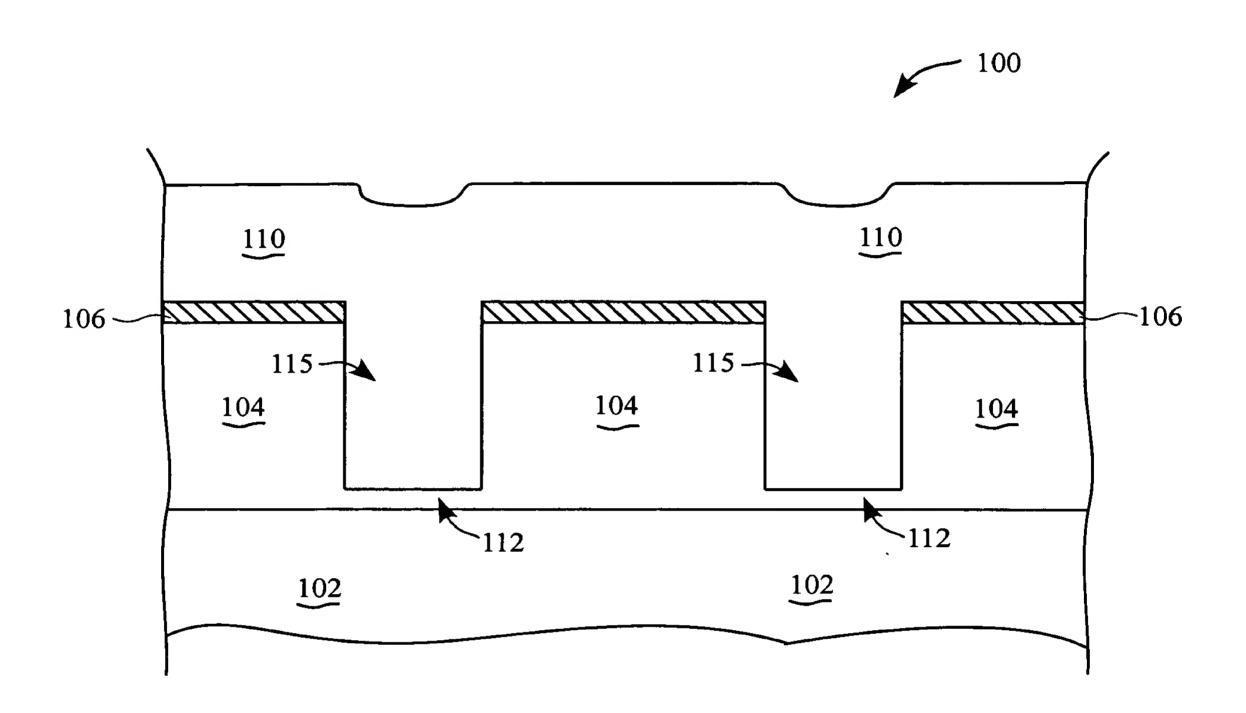


FIG. 2A

WAFER FOR CMP APPLICATIONS

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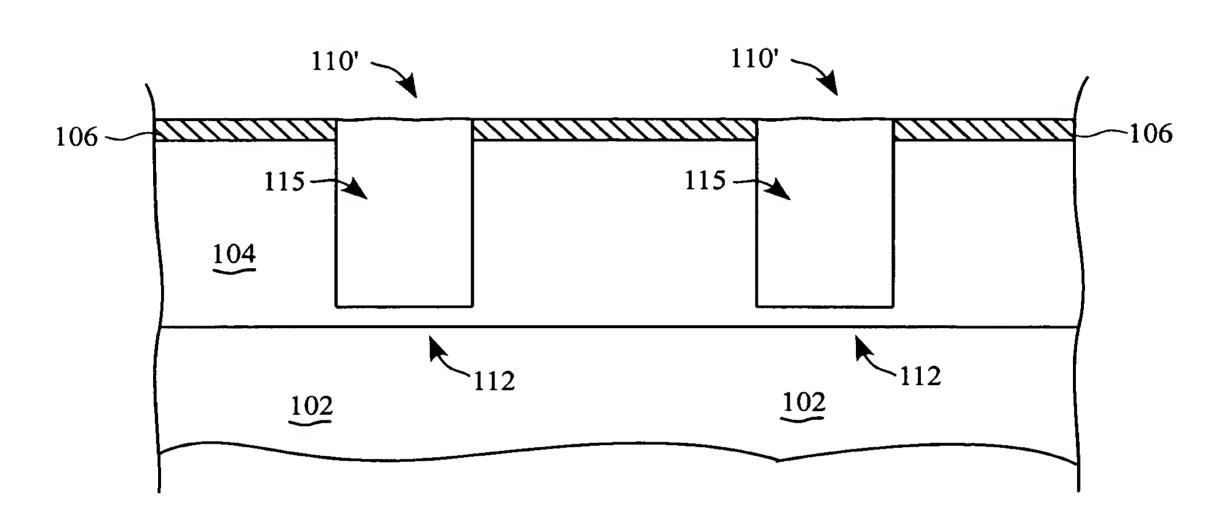


FIG. 2B

WAFER FOR CMP APPLICATIONS



FIG. 2C

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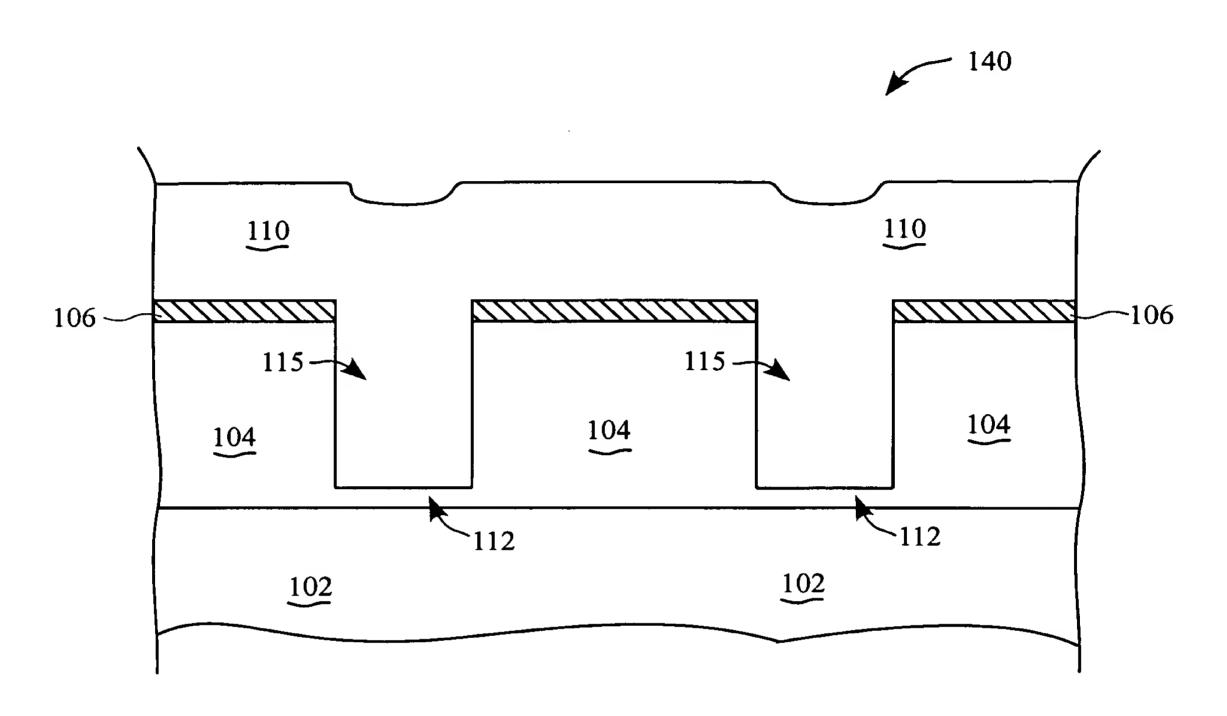


FIG. 2D

WAFER FOR CMP APPLICATIONS

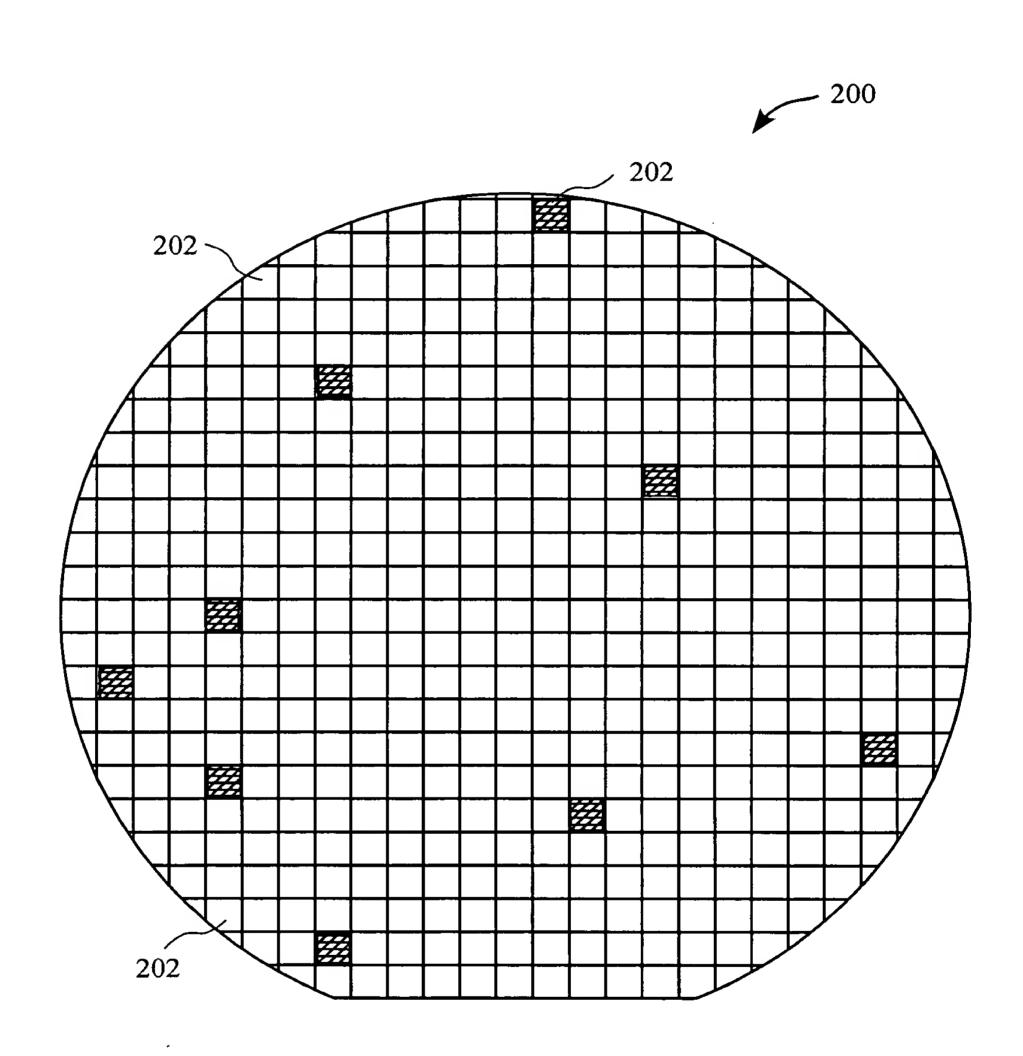


FIG. 3A

WAFER FOR CMP APPLICATIONS

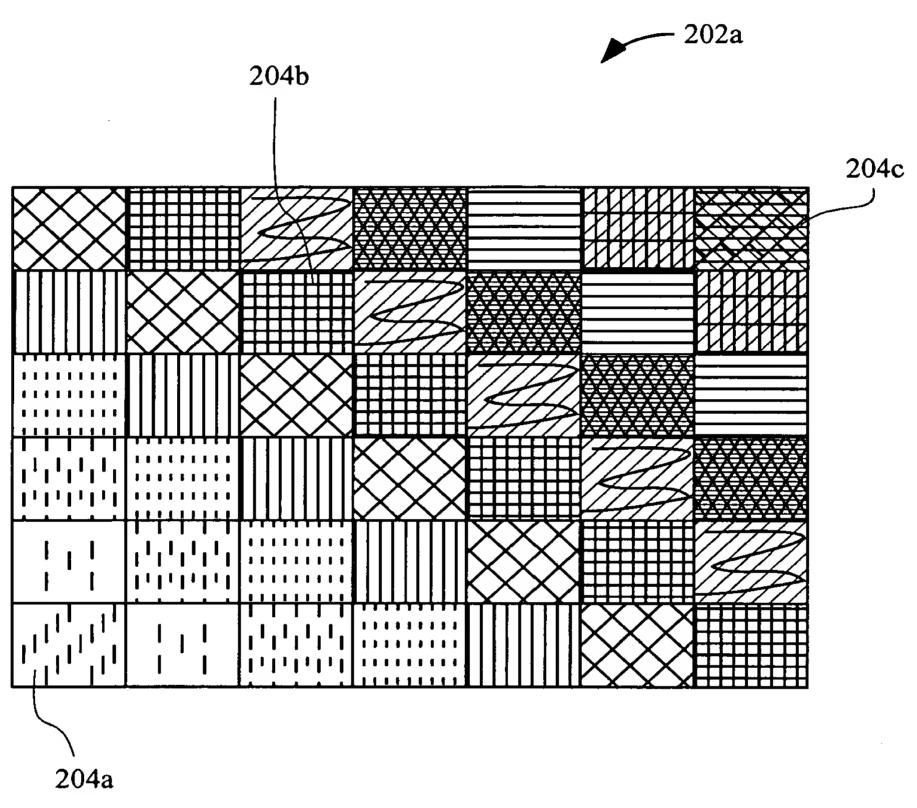


FIG. 3B

WAFER FOR CMP APPLICATIONS

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202b

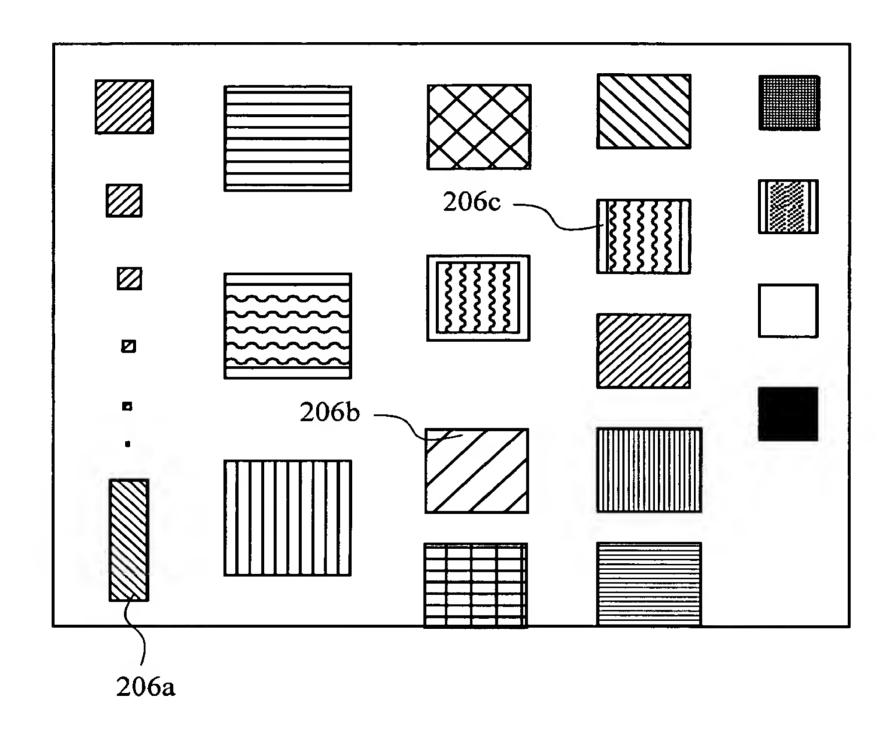


FIG. 3C

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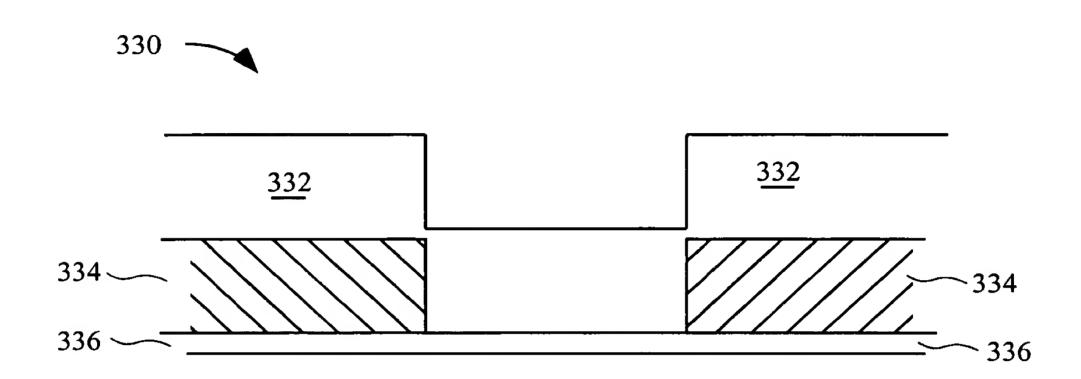


FIG. 4A

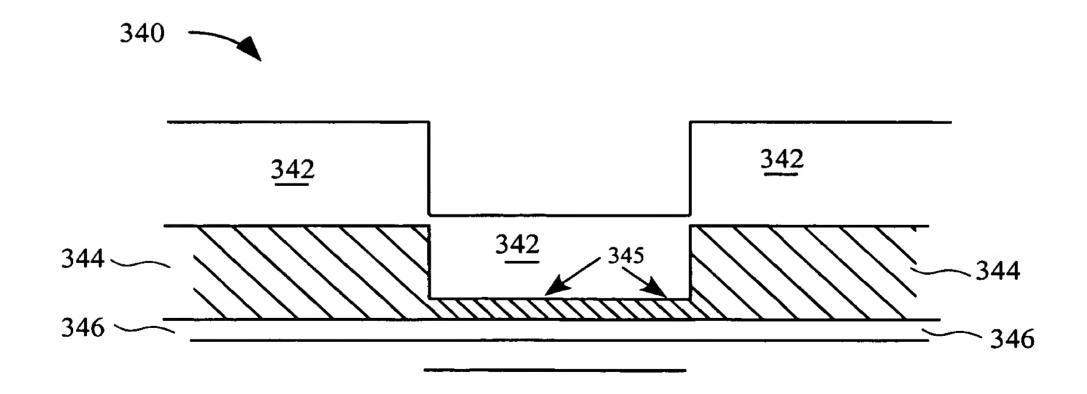


FIG. 4B

WAFER FOR CMP APPLICATIONS

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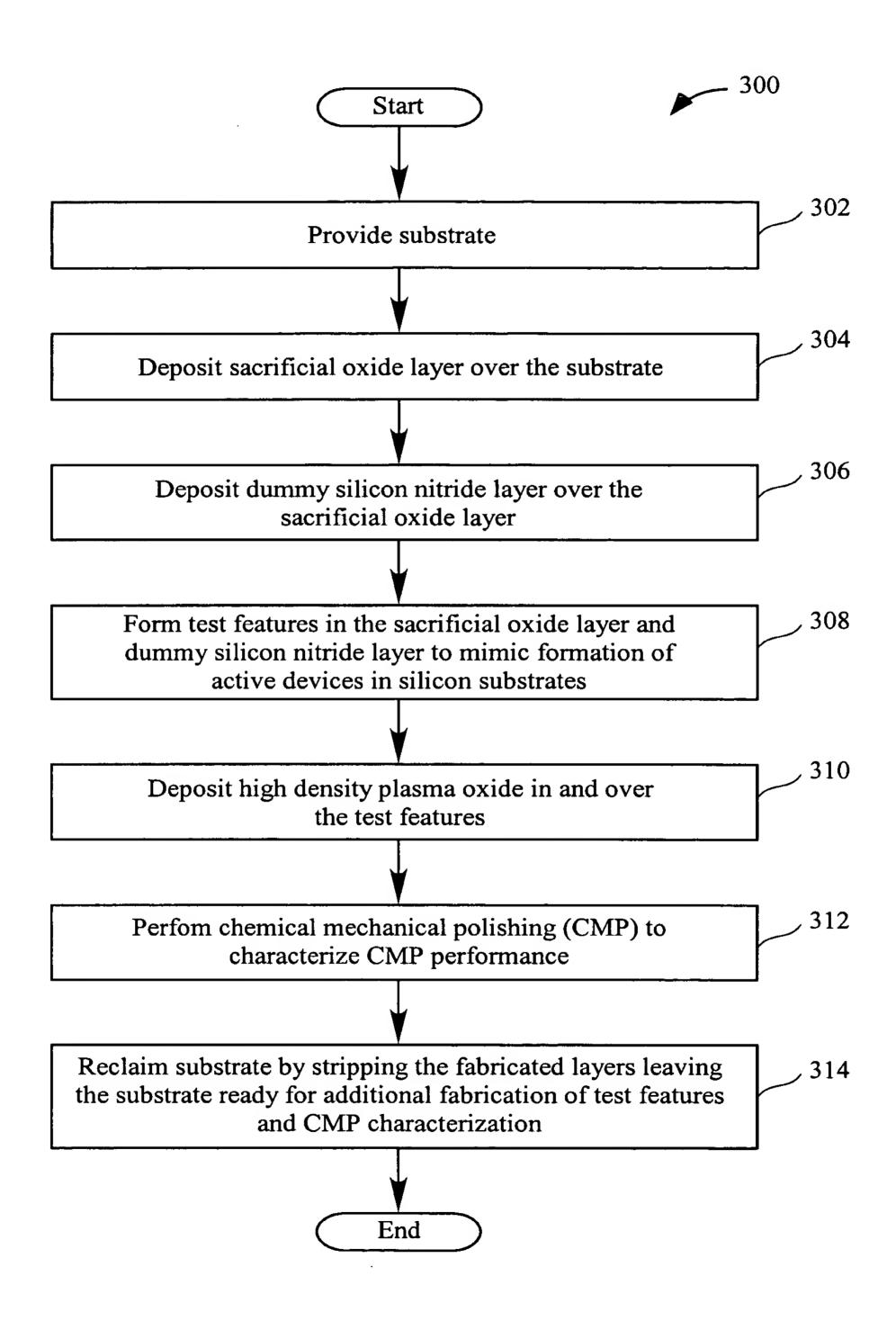


FIG. 5